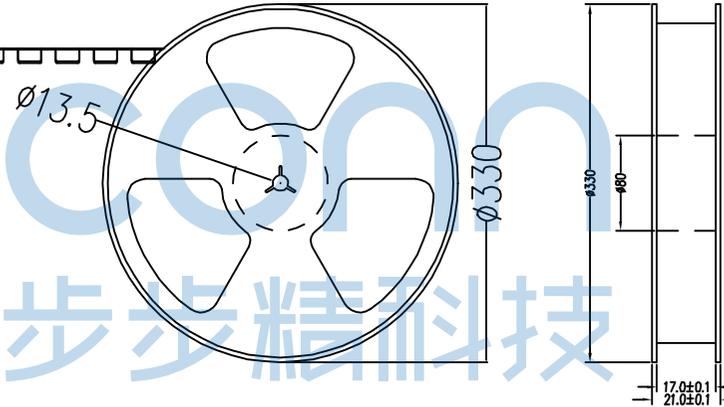
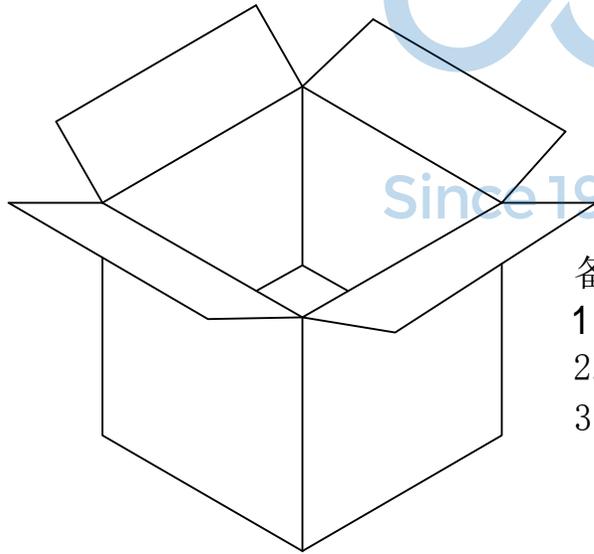
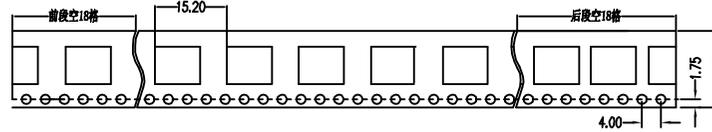
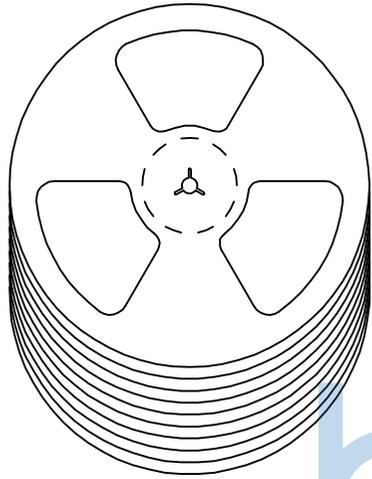


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



备注:

1. 包装数量：1000/PCS/卷，10卷/箱
2. 包装袋长度：每卷前后各空10-20个空格，中间包装。
3. 材质：
载体：聚丙烯（PS），
上带：聚乙烯（PET），
卷盘：聚苯乙烯。

纸箱规格：345*345*23MM

纸箱规格：345*345*35MM

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APPD.	JM_Zheng	CHKD.	LYX	DR.	TSP
PDWG.NO:	0361-1				